

TPS63805EVM-026

This user's guide describes the operation, and use of the TPS63805EVM-026 evaluation module (EVM). The TPS63805EVM-026 is designed to help the users easily evaluate and test the operation and functionality of the TPS63805 buck-boost converter. The TPS63805EVM-026 has the output voltage set to 3.3V.The EVM operates from 1.3V to 5.5V input voltage. Output current can go up to 2A in buck mode and boost mode. This document includes setup instructions for the hardware, a schematic diagram, a bill of materials (BOM), and printed-circuit board (PCB) layout drawings for the evaluation module. Throughout this document, the abbreviations EVM, TPS63805EVM-026, and the term evaluation module are synonymous with the TPS63805, unless otherwise noted.

Contents

1	Introduction	
2	Setup	2
3	Board Layout	4
4	Schematic and Bill of Materials	7
	List of Figures	
1	Assembly Layer	
2	Top Layer Routing	4
3	Signal layer 1	5
4	Signal Layer 2	5
5	Bottom Layer Routing	6
6	Schematic	7
	List of Tables	
1	Performance Specification Summary	2
2	TPS63805EVM-026 Bill of Materials	8

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1 Introduction

The Texas Instruments TPS63805 is a highly efficient, single-inductor, internally compensated, buck-boost converter in a 15-pin, 2.3-mm × 1.4-mm WCSP package. Both fixed and adjustable output voltage units are available.

1.1 Background

The TPS63805EVM-026 uses the TPS63805 integrated circuit (IC) and is set to a 3.3V output and operates with an input voltage between 1.3V and 5.5V.



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1.2 Performance Specification

Table 1 provides a summary of the TPS63805EVM-026 performance specifications. All specifications are given for an ambient temperature of 25°C.

Table 1. Performance Specification Summary

Specification	Test Conditions	Min	Тур Мах	Unit
Input voltage		1.3	5.5	V
Start-up input voltage		1.8	5.5	V
Output voltage		1.8	5.5	mA
Output current	VIN ≥ 2.2V , Vout=3.3V	0	2000	mA

1.3 Modifications

The printed-circuit board (PCB) for this EVM is designed to accommodate the TPS63805. Extra positions are available for additional input and output capacitor and feed forward capacitor.

1.3.1 IC U1 Operation

U1 is configured for evaluation of the adjustable-output version. This EVM is set to 3.3 V. Resistors R1and R2 can be used to set the output voltage between 1.8V and 5.5 V. See the datasheet for recommended values.

1.3.2 Precise Device Enable Evaluation

Components R3, R4 and C11 can be populated to evaluate the precise device enable feature of this IC. For further details please refer to the datasheet.

2 Setup

This section describes how to properly use the TPS63805EVM-026.

2.1 Input/Output Connector and Header Descriptions

2.1.1 J1, Pin 1 and 2 - VIN

Positive input connection from the input supply for the EVM.

2.1.2 J1, Pin 3 and 4 – S+/S-

Input voltage sense connections. Measure the input voltage at this point.

2.1.3 J1, Pin 5 and 6 - GND

Vin GND return connection from the input supply for the EVM, common with J2, pin 5 and 6.

2.1.4 J2, Pin 1 and 2 - VOUT

Output voltage connection.

2.1.5 J2, Pin 3 and 4 – S+/S-

Vout Sense and GND Sense low-current sense lines for sampling the output voltage at the output capacitor.

2.1.6 J2, Pin 5 and 6 - GND

Vout GND return connection for the output voltage, common with J1 pin 5 and 6.



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2.1.7 J5 - PG GND

Power Good (PG) test point and GND connection.

2.1.8 JP1 – MODE

Shorting jumper between the center pin MODE and PFM enables automatic transition to power-saving mode at light-load currents as described in the data sheet; shorting jumper between the center pin MODE and PWM enables forced PWM mode.

2.1.9 JP2 - ENABLE

Shorting jumper between the center pin EN and ON turns on the unit. Shorting jumper between the center pin EN and OFF turns the unit off.

2.2 Setup

To operate the EVM, connect an input supply with the positive lead to J1, pins 1 and 2 and negative lead to J1, pins 5 and 6; connect a load with the positive lead to J2, pins 1 and 2 and the negative lead to J2, pins 5 and 6; short EN and ON (pins 2 and 3) of JP2 with a shorting jumper.



Board Layout www.ti.com

3 Board Layout

This section provides the TPS63805EVM-026 board layout and illustrations.

3.1 Layout

Figure 1 through Figure 5 show the board layout for the TPS63805EVM-026 PCB.

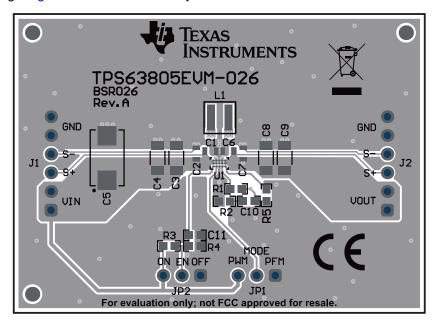


Figure 1. Assembly Layer

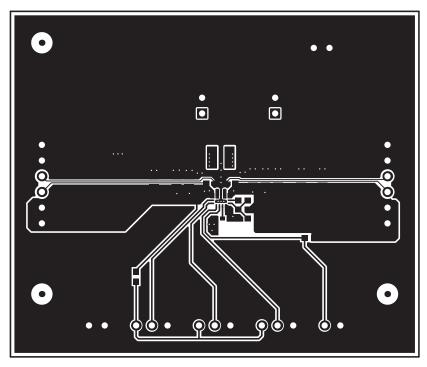


Figure 2. Top Layer Routing



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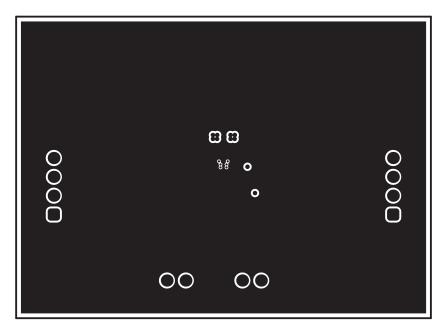


Figure 3. Signal layer 1

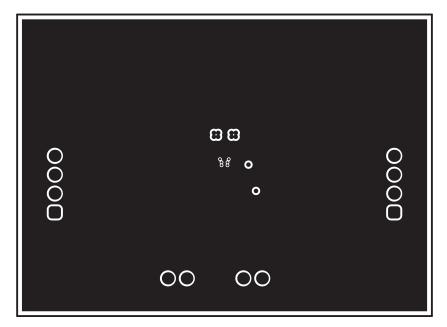


Figure 4. Signal Layer 2



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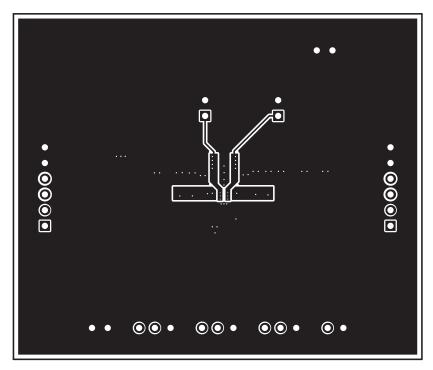


Figure 5. Bottom Layer Routing



www.ti.com Schematic and Bill of Materials

4 Schematic and Bill of Materials

This section provides the TPS63805EVM-026 schematic and bill of materials.

4.1 Schematic

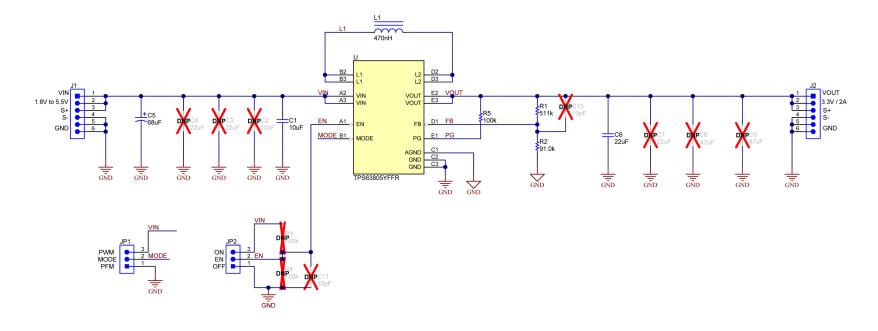


Figure 6. Schematic



4.2 Bill of Materials

Table 2. TPS63805EVM-026 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
1	C1	10μF	CAP, CERM, 10 µF, 6.3 V, +/- 20%, X5R, 0603	603	GRM188R60J106ME84	Murata
1	C5	68µF	CAP, TA, 68 μF, 20 V, +/- 10%, 0.15ohm	7343-31	T495D686K020ATE150	Kemet
1	C6	22µF	CAP, CERM, 22 µF, 6.3 V, +/- 20%, X5R, 0603	805	GRM188R60J226MEA0D	Murata
1	L1	470nH	Inductor, Shielded, Composite, 470 nH, 3.5A, 76mohm	4x4x1.5mm	XFL4015-471MEC	Coilcraft
1	R1	511k	RES, 511 k, 1%, 0.1 W, 0603	603	Std	Std
1	R2	91.0k	RES, 91.0 k, 1%, 0.1 W, 0603	603	Std	Std
1	R5	100k	RES, 100 k, 1%, 0.1 W, 0603	603	Std	Std
1	U1	-	IC, Single Inductor Buck-Boost Converter	RNM0015A	TPS63805YFF	TI

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